

Transmission Laser Modules

Key Features

InGaAsP monolithically integrated DFB laser and modulator in-house chip

Low drive voltage ($\leq 2V_{pp}$)

Very low dispersion penalty up to 40 km for 10.7Gbit/s operation (up to 800ps/nm)

XMD MSA compliant

FPC for electrical connections

RoHs Compliant

Applications

STM-64 (Short-Haul) and OC-192 (Intermediate-Reach) XFP Transceiver

For more Info

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1925 LMM

10 Gb/s Electro-Absorptive Integrated Laser Modulator Optical Sub-Assembly 800 ps/nm – DWDM – LC Receptacle

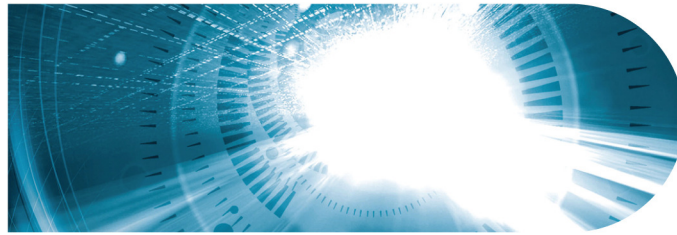
This 1925 LMM contains a 3S PHOTONICS DFB laser with monolithically integrated electro-absorption modulator.

The modulation voltage is applied to the modulator section while the DFB laser operates CW. Without the complexity of LiNbO3 external modulators, the 1925 LMM is dedicated to STM64 / OC-192 bit rate with reduced size and cost. This device allows 10 Gbit/s data transmission in compliance with ITU-T standards.

The 1925 LMM is optimized for up to 10.7Gbit/s DWDM transmission systems supporting dispersion up to 800 ps/nm.



**10 Gb/s Electro-Absorptive
Integrated Laser Modulator
Optical Sub-Assembly
800 ps/nm – DWDM –
LC Receptacle**



OPTICAL CHARACTERISTICS

Table 1

Parameters	Symb	Test conditions	Min	Max	Units
Operating case temperature	T _c		-5	75	°C
Laser Threshold current	I _{th}	VBM	5	35	mA
Laser operating current	I _{op}	VBM, T _{wave}	70	100	mA
Laser chip temperature range for tunability	T _{wave}		30	40	°C
Modulator bias voltage	VBM		-2	0	V
Modulator drive voltage	V _{pp}	Note 1		2.5	V _{pp}
Average optical output power	P _{AVE}	I _{op} , DER, λ _c , notes 1, 2	-1	+2	dBm
Center wavelength range	λ _c	@ I _{op} , T _{wave}	1528.77	1563.86	nm
Wavelength tuning coefficient	Δλ/°C		80	100	pm/°C
Wavelength tolerance BOL	Δλ _{BOL}	@ I _{op} , T _{wave} , BOL	-20	+20	pm
Wavelength tolerance EOL	Δλ _{EOL}	@ I _{op} , T _{wave} , 15 years	-100	+100	pm
Center wavelength drift with Case Temperature	Δλ/ΔT _c	T _c =[-5;75]°C @T _{wave}	-0.5	+0.5	pm/°C
Wavelength drift with laser current	Δλ/ΔI	@ T _{wave} , VBM	4	15	pm/mA
Side Mode Suppression Ratio	SMSR	Note 1	35		dB
Dynamic Extinction Ratio BOL	DER	I _{op} , notes 1, 2	9		dB
Dispersion penalty	ΔS	DER, notes 1, 2		2	dB
Monitor diode current	I _m	I _{op} , V=-5V	50	1000	μA
Dark current	I _d			0.1	μA
TEC current	I _t	P _{AVE} op, VBM op, I _{op} , ΔT=75°C-T _{wave}		1.3	A
TEC voltage	V _t			2.3	V
TEC power	W _{TEC}	P _{AVG} op VBM op, I _{op} , ΔT=75°C-T _{wave}		1.5	W
Thermistor resistance	R _{TH}	T _s =25°C	9.5	10.5	KΩ
Thermistor β coefficient	β	T _s =25°C	3800	4000	K

Note 1 : BER= 10⁻¹⁰, 10.7Gb/s, modulation, 231-1 PRBS, NRZ line code, driver OKI 4145KW

Note 2 : 800 ps/nm minimum dispersion @ 1550nm. A PIN-TIA receiver with sensitivity better than -18 dBm BER 1E-10 in Back to Back is used.

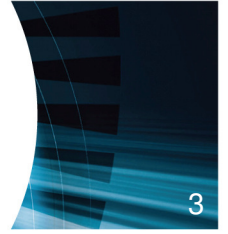
ABSOLUTE MAXIMUM RATINGS

Table 2

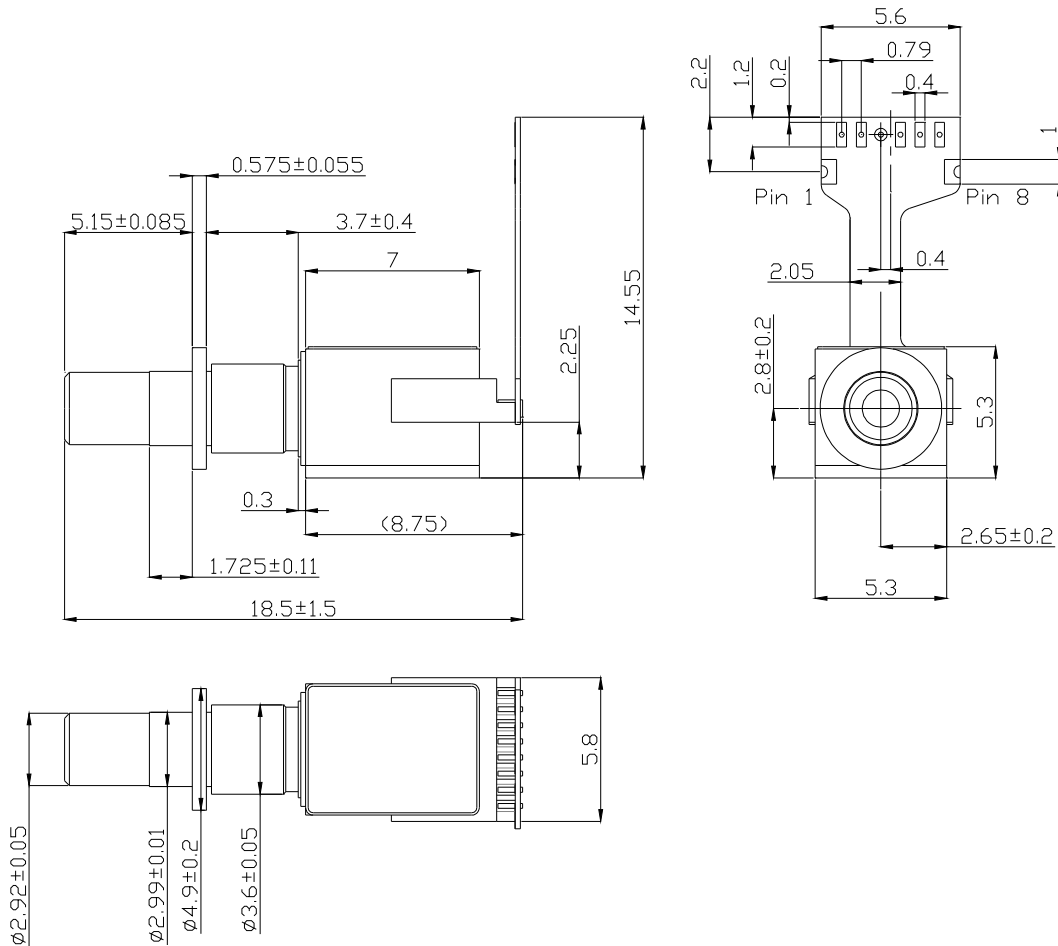
Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameters	Min	Max	Unit
Storage case temperature	-40	+85	°C
Laser Forward Current		150	mA
Laser Reverse Voltage		2	V
Laser Reverse Current		10	μA
Modulator Forward Voltage		1	V
Modulator Forward Current		100	mA
Modulator Reverse Voltage		5	V
Modulator Reverse Current		10	μA
Photodiode Forward Current		1	mA
Photodiode Reverse Voltage		20	V
TEC Voltage		2.6	V
TEC Current		1.3	A
Flex pad soldering Temperature (5s)		290	°C
Flex pad allowed soldering rework		1	time
Flex torsion angle	-10	10	°
Flex (FPC) bending radius	2		mm

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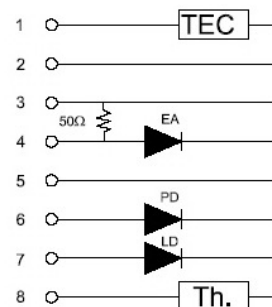


MECHANICAL DETAILS

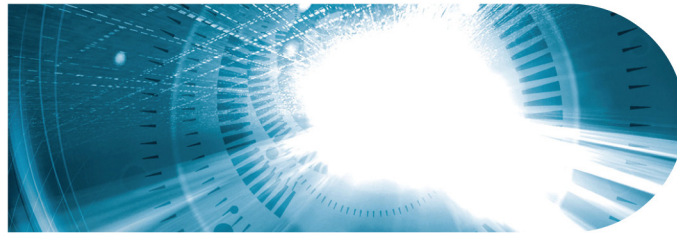


PIN OUT

N°	Description
1	TE Cooler Cathode
2	TE Cooler Anode
3	Floating signal ground
4	Modulator Anode (bias-)
5	Floating signal ground
6	PD Anode (bias-)
7	LD Anode (bias-)
8	Thermistor



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SHIPMENT PACKING

Each device is individually packed in an anti-static container and in such a manner as to prevent damage in transit.

The packing shall include the following information:

3S PHOTONICS logo

Product family name : 1925 LMM

Product code : 3CN number (see Ordering information section)

Serial number

Hazard warning label (ESD)

Laser Safety Class Label

DELIVERABLE DATA

The following data shall be supplied with each device under EDF format:

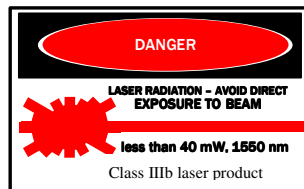
Ith, Imon, It, Vt, Pt, If, Tlaser, Pave, DER, DS, Driver Modulation Voltage, Driver Offset Voltage, Driver Eye Crossing Voltage

LASER SAFETY INFORMATION

Take appropriate precautions to prevent undue exposure to naked eye.

This product is classified Class 1M Laser Product according to IEC-60825-1: edition2.

All versions are Class IIIB laser products per 21 CFR 1040-10 Laser. Safety requirements under accession number 0120546-00.

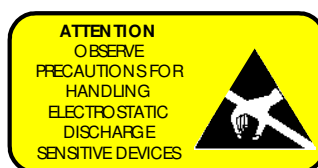


HANDLING

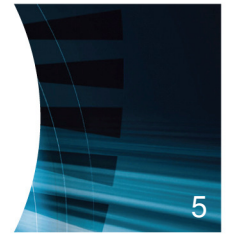
This product is sensitive to electrostatic discharge and should not be handled except at a static free workstation. Take precautions to prevent ESD; use wrist straps, grounded work surfaces and recognized anti-static techniques when handling the module.

Handle the PD module by its package only, never hold it by its receptacle.

Care should be taken to avoid supply transient and over voltage. Over voltage above the maximum specified in absolute maximum rating section may cause permanent damage to the device.



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ORDERING INFORMATION

1925 LMM
LC receptacle – FPC

Application	Part number	Output Power	Case Temperature
800 ps/nm – DWDM	3CN01631##	[-1, +2] dBm	Commercial

defines the wavelength according to the Table 3.

Table 3

λ (1)	THz	Code ##	λ (1)	THz	Code ##
1528,77	196,10	BM	1546,92	193,80	DK
1529,55	196,00	BP	1547,72	193,70	DM
1530,33	195,90	BR	1548,51	193,60	DP
1531,12	195,80	BT	1549,32	193,50	DR
1531,90	195,70	BV	1550,12	193,40	DT
1532,68	195,60	BX	1550,92	193,30	DV
1533,47	195,50	BZ	1551,72	193,20	DX
1534,25	195,40	CB	1552,52	193,10	DZ
1535,04	195,30	CD	1553,33	193,00	EB
1535,82	195,20	CF	1554,13	192,90	ED
1536,61	195,10	CH	1554,94	192,80	EF
1537,40	195,00	CK	1555,75	192,70	EH
1538,19	194,90	CM	1556,56	192,60	EK
1538,98	194,80	CP	1557,36	192,50	EM
1539,77	194,70	CR	1558,17	192,40	EP
1540,56	194,60	CT	1558,98	192,30	ER
1541,35	194,50	CV	1559,79	192,20	ET
1542,14	194,40	CX	1560,61	192,10	EV
1542,94	194,30	CZ	1561,42	192,00	EX
1543,73	194,20	DB	1562,23	191,90	EZ
1544,53	194,10	DD	1563,05	191,80	FB
1545,32	194,00	DF	1563,86	191,70	FD
1546,12	193,90	DH			

All wavelengths referenced to vacuum, Twave for WDM applications.

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Please note: information in this document is typical and must be specifically confirmed in writing by your supplier before it becomes applicable to any order or contract. Information is subject to change without notice.
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ORDERING INFO

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